

TC74LVX74F, TC74LVX74FN, TC74LVX74FT

Dual D-Type Flip-Flop with Preset and Clear

The TC74LVX74F/ FN/ FT is a high-speed CMOS D-flip flop fabricated with silicon gate CMOS technology. Designed for use in 3-V systems, it achieves high-speed operation while maintaining the CMOS low power dissipation.

This device is suitable for low-voltage and battery operated systems.

The signal level applied to the D input is transferred to Q output during the positive going transition of the CK pulse.

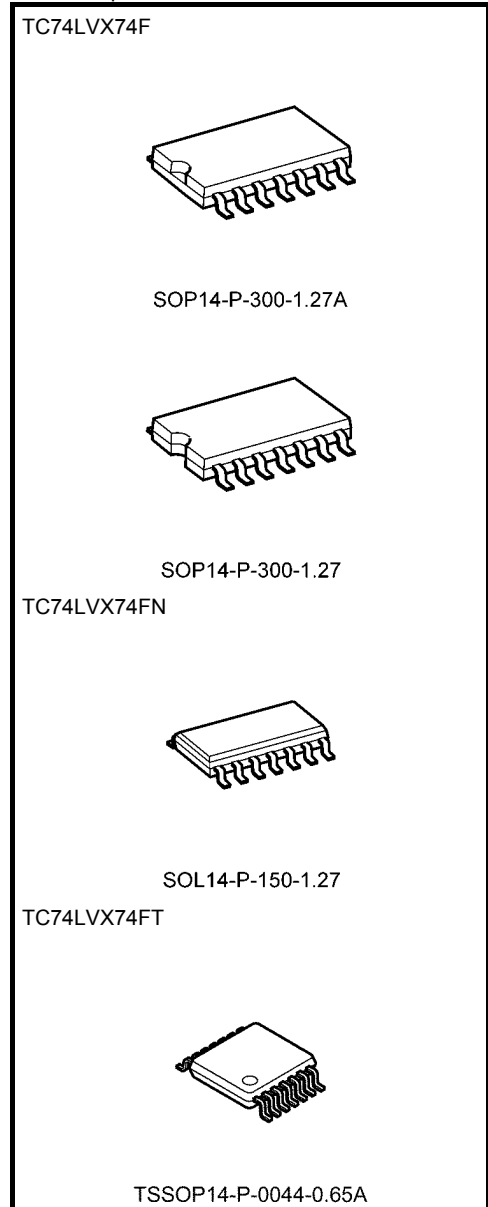
CLR and PR are independent of the CK and are accomplished by setting the appropriate input low.

An input protection circuit ensures that 0 to 5.5V can be applied to the input pins without regard to the supply voltage. This device can be used to interface 5V to 3V systems and two supply systems such as battery back up. This circuit prevents device destruction due to mismatched supply and input voltages.

Features

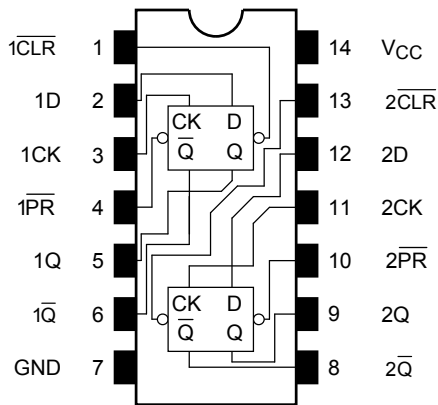
- High-speed: $f_{max} = 145 \text{ MHz (typ.) (VCC = 3.3 V)}$
- Low power dissipation: $I_{CC} = 2 \mu\text{A (max) (Ta = 25^\circ\text{C})}$
- Input voltage level: $V_{IL} = 0.8 \text{ V (max) (VCC = 3 V)}$
 $V_{IH} = 2.0 \text{ V (min) (VCC = 3 V)}$
- Power-down protection provided on all inputs
- Balanced propagation delays: $t_{pLH} \approx t_{pHL}$
- Pin and function compatible with 74HC74

Note: xxxFN (JEDEC SOP) is not available in Japan.

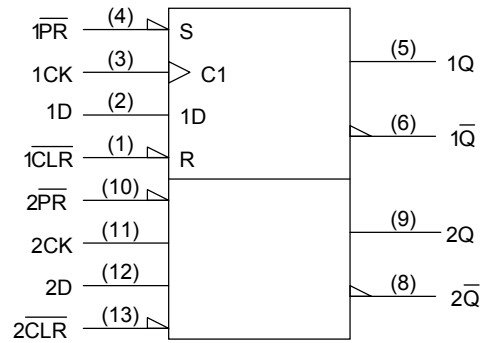


Weight	
SOP14-P-300-1.27A	: 0.18 g (typ.)
SOP14-P-300-1.27	: 0.18 g (typ.)
SOL14-P-150-1.27	: 0.12 g (typ.)
TSSOP14-P-0044-0.65A	: 0.06 g (typ.)

Pin Assignment (top view)



IEC Logic Symbol



Truth Table

Inputs				Outputs		Function
CLR	PR	D	CK	Q	Q̄	
L	H	X	X	L	H	Clear
H	L	X	X	H	L	Preset
L	L	X	X	H	H	—
H	H	L	↑	L	H	—
H	H	H	↑	H	L	—
H	H	X	↓	Q _n	Q̄ _n	No change

X: Don't care

Absolute Maximum Ratings (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage range	V _{CC}	-0.5 to 7.0	V
DC input voltage	V _{IN}	-0.5 to 7.0	V
DC output voltage	V _{OUT}	-0.5 to V _{CC} + 0.5	V
Input diode current	I _{IK}	-20	mA
Output diode current	I _{OK}	±20	mA
DC output current	I _{OUT}	±25	mA
DC V _{CC} /ground current	I _{CC}	±50	mA
Power dissipation	P _D	180	mW
Storage temperature	T _{stg}	-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Recommended Operating Conditions (Note)

Characteristics	Symbol	Rating	Unit
Supply voltage	V_{CC}	2.0 to 3.6	V
Input voltage	V_{IN}	0 to 5.5	V
Output voltage	V_{OUT}	0 to V_{CC}	V
Operating temperature	T_{opr}	-40 to 85	°C
Input rise and fall time	dt/dv	0 to 100	ns/V

Note: The recommended operating conditions are required to ensure the normal operation of the device. Unused inputs must be tied to either VCC or GND.

Electrical Characteristics

DC Characteristics

Characteristics		Symbol	Test Condition	Ta = 25°C			Ta = -40 to 85°C		Unit			
				V _{CC} (V)	Min	Typ.	Max	Min		Max		
Input voltage	H-level	V_{IH}	—	2.0	1.5	—	—	1.5	—	V		
				3.0	2.0	—	—	2.0	—			
				3.6	2.4	—	—	2.4	—			
	L-level	V_{IL}		2.0	—	—	0.5	—	0.5			
				3.0	—	—	0.8	—	0.8			
				3.6	—	—	0.8	—	0.8			
Output voltage	H-level	V_{OH}	$V_{IN} = V_{IH}$ or V_{IL}	$I_{OH} = -50 \mu A$	2.0	1.9	2.0	—	1.9	—	V	
				$I_{OH} = -50 \mu A$	3.0	2.9	3.0	—	2.9	—		
				$I_{OH} = -4 mA$	3.0	2.58	—	—	2.48	—		
	L-level	V_{OL}		$V_{IN} = V_{IH}$ or V_{IL}	$I_{OL} = 50 \mu A$	2.0	—	0	0.1	—		0.1
					$I_{OL} = 50 \mu A$	3.0	—	0	0.1	—		0.1
					$I_{OL} = 4 mA$	3.0	—	—	0.36	—		0.44
Input leakage current		I_{IN}	$V_{IN} = 5.5 V$ or GND		3.6	—	—	±0.1	—	±1.0	μA	
Quiescent supply current		I_{CC}	$V_{IN} = V_{CC}$ or GND		3.6	—	—	2.0	—	20.0	μA	

Timing Requirements (input: $t_r = t_f = 3 ns$)

Characteristics	Symbol	Test Condition	Ta = 25°C		Ta = -40 to 85°C		Unit
			V _{CC} (V)	Limit	Limit		
Minimum pulse width (CK)	$t_W (L)$	—	2.7	8.5	10.0	ns	
	$t_W (H)$		3.3 ± 0.3	6.0	7.0		
Minimum pulse width (\overline{CLR} , \overline{PR})	$t_W (L)$	—	2.7	8.5	10.0	ns	
			3.3 ± 0.3	6.0	7.0		
Minimum set-up time	t_s	—	2.7	8.0	9.5	ns	
			3.3 ± 0.3	5.5	6.5		
Minimum hold time	t_h	—	2.7	0.5	0.5	ns	
			3.3 ± 0.3	0.5	0.5		
Minimum removal time (\overline{CLR} , \overline{PR})	t_{rem}	—	2.7	6.5	7.5	ns	
			3.3 ± 0.3	5.0	5.0		

AC Characteristics (input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	Ta = 25°C			Ta = -40 to 85°C		Unit		
			V _{CC} (V)	C _L (pF)	Min	Typ.	Max		Min	Max
Propagation delay time (CK-Q, \bar{Q})	t _{pLH}	—	2.7	15	—	7.3	15.0	1.0	18.5	ns
				50	—	9.8	18.5	1.0	22.0	
	3.3 ± 0.3		15	—	5.7	9.7	1.0	11.5		
			50	—	8.2	13.2	1.0	15.0		
Propagation delay time (\bar{CLR} , \bar{PR} -Q, \bar{Q})	t _{pLH}	—	2.7	15	—	8.4	15.6	1.0	18.5	ns
				50	—	10.9	19.1	1.0	22.0	
	3.3 ± 0.3		15	—	6.6	10.1	1.0	12.0		
			50	—	9.1	13.6	1.0	15.5		
Maximum clock frequency	f _{max}	—	2.7	15	55	135	—	50	—	MHz
				50	45	60	—	40	—	
			3.3 ± 0.3	15	95	145	—	80	—	
				50	60	85	—	50	—	
Output to output skew	t _{osLH}	(Note 1)	2.7	50	—	—	1.5	—	1.5	ns
	t _{osHL}			3.3 ± 0.3	50	—	—	1.5	—	
Input capacitance	C _{IN}	(Note 2)		—	4	10	—	10	pF	
Power dissipation capacitance	C _{PD}	(Note 3)		—	25	—	—	—	pF	

Note 1: Parameter guaranteed by design.
($t_{osLH} = |t_{pLHm} - t_{pLHn}|$, $t_{osHL} = |t_{pHLm} - t_{pHLn}|$)

Note 2: Parameter guaranteed by design.

Note 3: C_{PD} is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption.

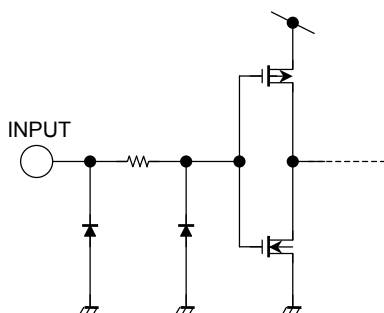
Average operating current can be obtained by the equation:

$$I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}/2 \text{ (per F/F)}$$

Noise Characteristics (Ta = 25°C, input: $t_r = t_f = 3$ ns, C_L = 50 pF)

Characteristics	Symbol	Test Condition	V _{CC} (V)	Typ.	Limit	Unit
			3.3			
Quiet output maximum dynamic V _{OL}	V _{OLP}	—	3.3	0.3	0.5	V
Quiet output minimum dynamic V _{OL}	V _{OLV}	—	3.3	-0.3	-0.5	V
Minimum high level dynamic input voltage V _{IH}	V _{IHD}	—	3.3	—	2.0	V
Maximum low level dynamic input voltage V _{IL}	V _{ILD}	—	3.3	—	0.8	V

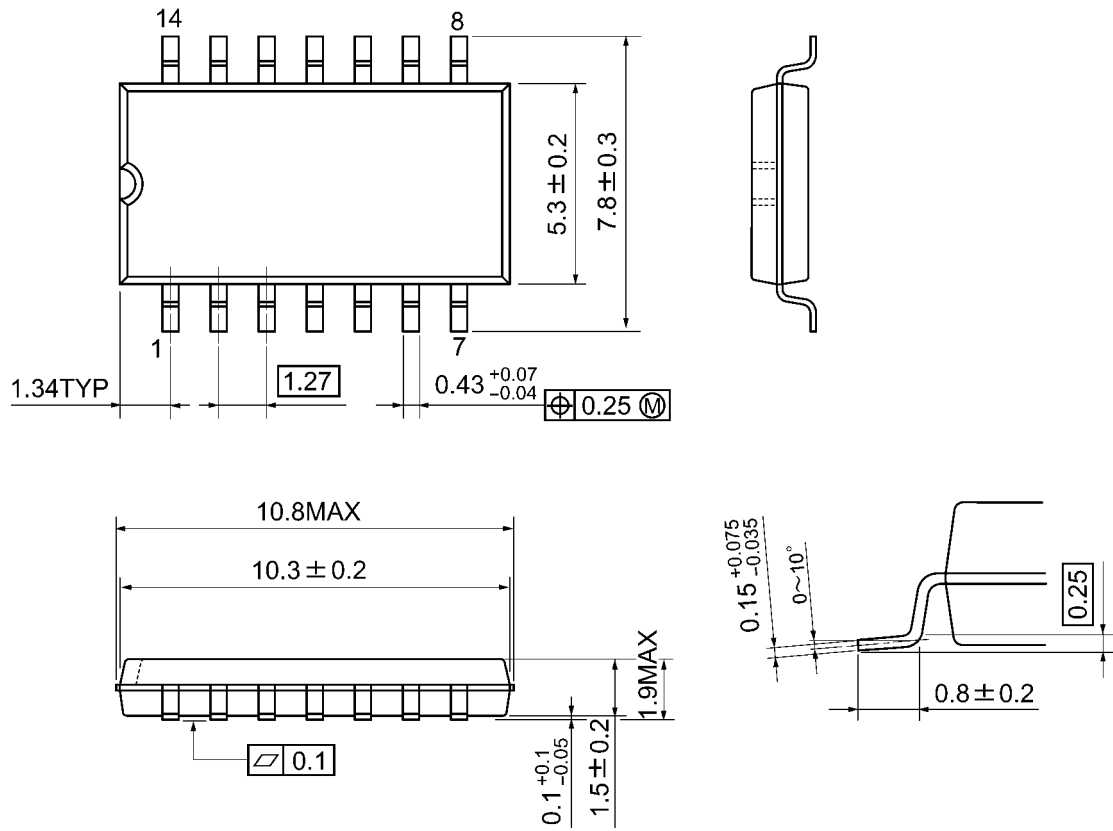
Input Equivalent Circuit



Package Dimensions

SOP14-P-300-1.27A

Unit: mm

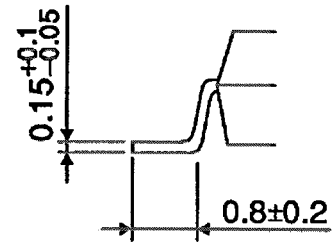
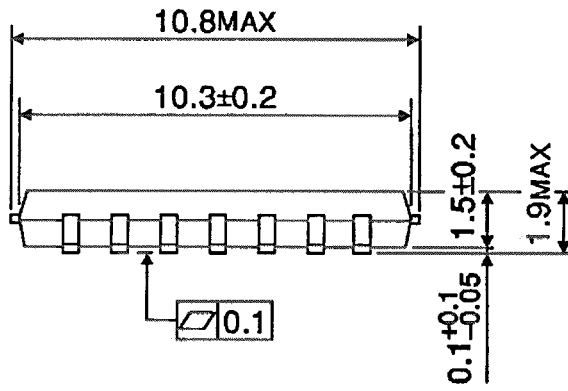
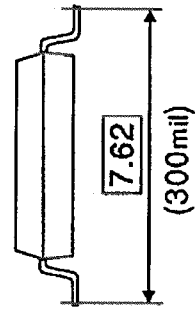
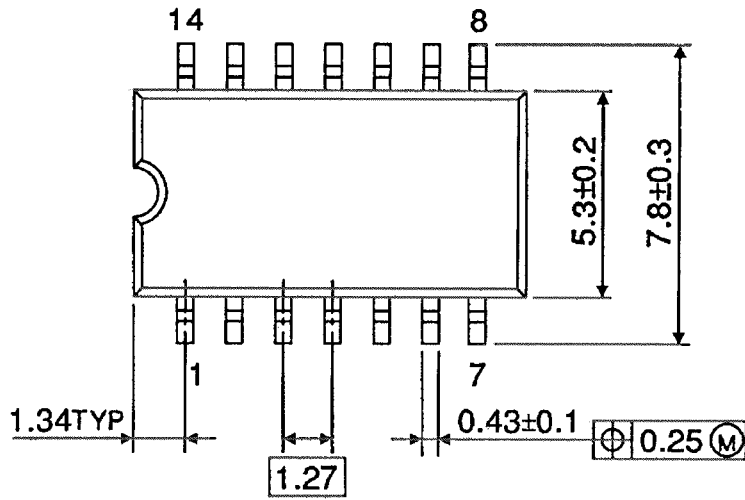


Weight: 0.18 g (typ.)

Package Dimensions

SOP14-P-300-1.27

Unit : mm

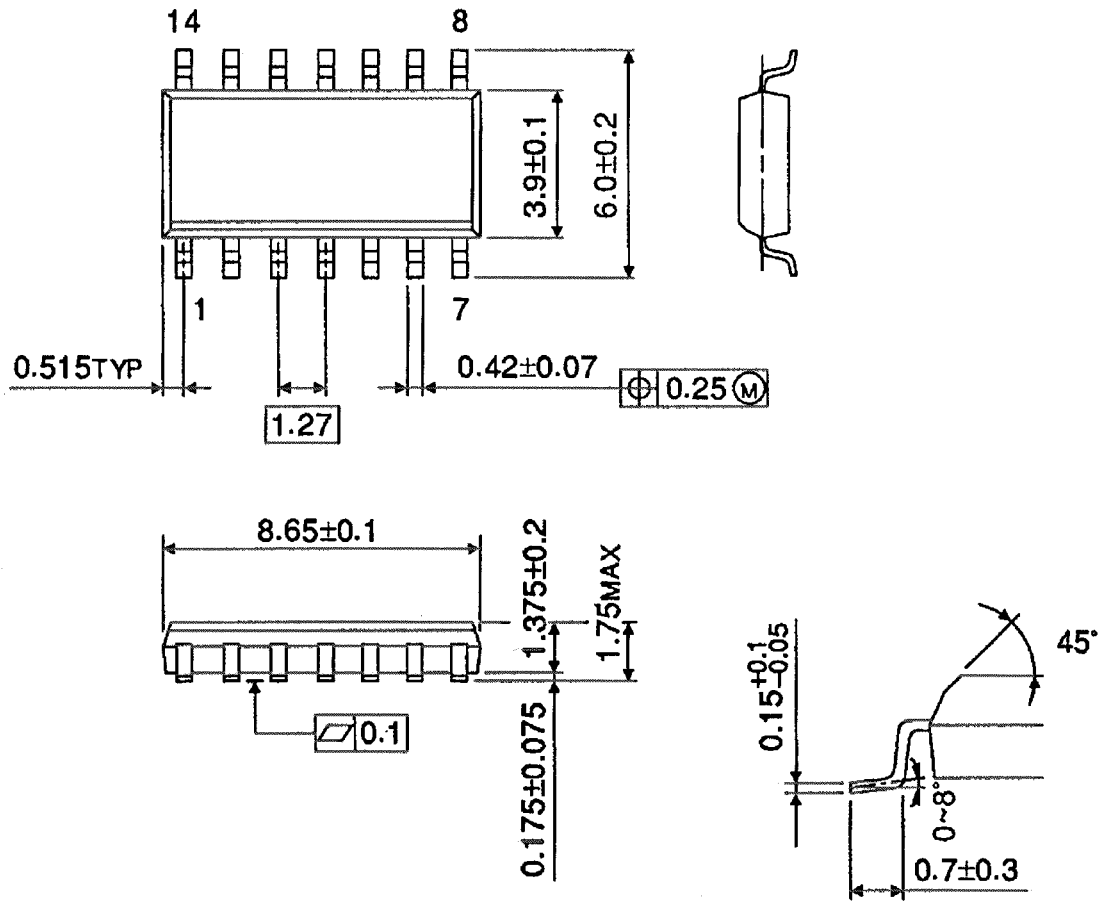


Weight: 0.18 g (typ.)

Package Dimensions (Note)

SOL14-P-150-1.27

Unit : mm



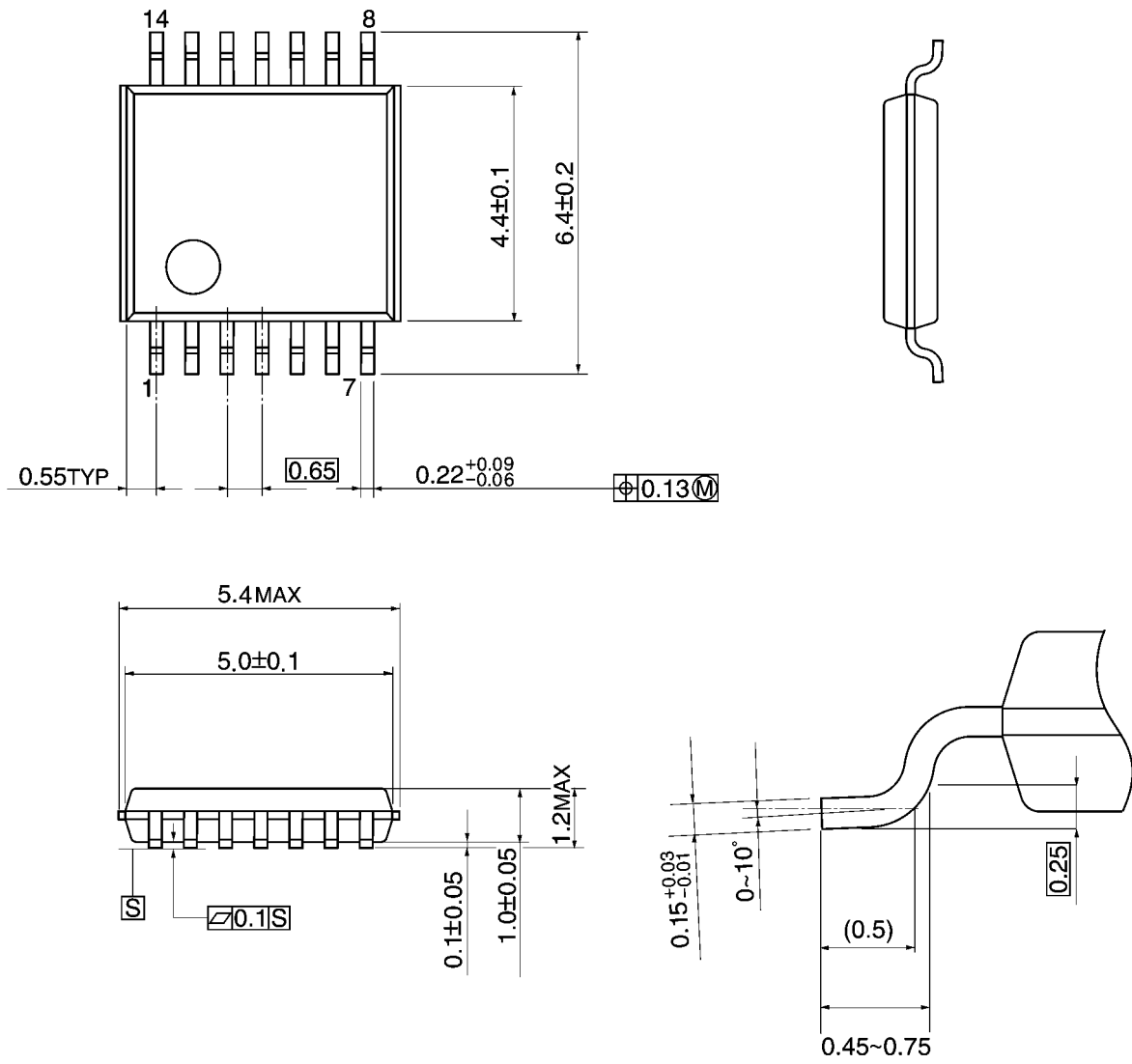
Note: This package is not available in Japan.

Weight: 0.12 g (typ.)

Package Dimensions

TSSOP14-P-0044-0.65A

Unit: mm



Weight: 0.06 g (typ.)

Note: Lead (Pb)-Free Packages**SOP14-P-300-1.27A SOL14-P-150-1.27 TSSOP14-P-0044-0.65A****RESTRICTIONS ON PRODUCT USE**

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